Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
U1	11254	((438/106) or (438/115) or (438/118) or (438/455) or (438/458) or (438/471) or (438/689) or (438/758) or (438/783) or (438/906) or (438/963) or (438/974) or (438/976)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 18:27
L2	· 92	1 and ((oxidiz\$5 with surface\$1) with (impurit\$3 or contamin\$5))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 18:28
L3	75	2 and ((clean\$3 or etch\$3 or remov\$3) with (impurit\$3 or contamin\$5))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 18:29
L4	9	3 and (oxidiz\$5 with ozone)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 18:30
S1.	6	(("6240933") or ("6312797") or ("6312797") or ("6240933") or ("2002066464") or ("2003205240") or ("2002157686") or ("2002050279") or ("2003205254") or ("6591845") or ("6273108") or ("6267125") or ("2001042555") or ("200102799") or ("2001027799") or ("2001017143") or ("20020020436")).PN.	US-PGPUB; USPAT; EPO	OR	OFF	2005/06/07 20:14

S2	6	(("6240933") or ("6312797") or ("6240933") or ("2002066464") or ("2003205240") or ("2002157686") or ("2002050279") or ("2003205254") or ("6591845") or ("6273108") or ("6267125") or ("2001042555") or ("2001029965") or ("2001027799") or ("2001017143") or ("20020020436")).PN.	US-PGPUB; USPAT; EPO	OR	OFF	2005/06/07 20:19
S3	3880	((438/115) or (438/118) or (438/455) or (438/758) or (438/906)):CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/06/07 20:49
S4	4	S1 and ((ozone near5 wafer\$1) same (clean\$3 near3 wafer\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/07 20:58
S5	8	S3 and ((ozone near5 wafer\$1) same (clean\$3 near3 wafer\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/07 20:53
S6	1	((ozone near5 wafer\$1) same (clean\$3 near3 wafer\$1)) same bond\$3 same oxidiz\$5	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/07 21:00
S7	30	((ozone near5 wafer\$1) same (clean\$3 near3 wafer\$1)) same oxidiz\$5 and bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/07 21:01
S8	9889	((438/106) or (438/115) or (438/118) or (438/455) or (438/458) or (438/689) or (438/758) or (438/906) or (438/963) or (438/974)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/05 16:42

S9	0	S8 and (ozone near5 hydrophillic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:31
S10	0	S8 and (ozone near10 hydrophillic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:31
S11	3	S8 and (ozone near5 hydrophilic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:36
S12	7	S8 and (ozone near10 hydrophilic)	US-PGPUB; USPAT; USOGR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:34
S13	. 4	S12 not S11	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:34
S14	1	(ozone near5 hydrophilic) near5 bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:37
S15	6	(ozone near5 hydrophilic) same bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 18:18
S16	5	S15 not S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:37

S17	103	(ozone near5 hydrophilic) and bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:38
S18	98	S17 not S16	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 18:19
S19	3	S18 and (wafer\$1 near5 bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:40
S20	3	S18 and (wafer\$1 near10 bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 17:40
S21	3	S18 and (wafer\$1 same bond\$3)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/12/03 18:18
S22	1	("20020155709").PN.	US-PGPUB; USPAT	OR	OFF	2005/12/03 18:19
S23	10815	((438/106) or (438/115) or (438/118) or (438/455) or (438/458) or (438/689) or (438/758) or (438/783) or (438/906) or (438/963) or (438/974) or (438/976)).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 18:27
S24	88	S23 and ((oxidiz\$5 with surface\$1) with (impurit\$3 or contamin\$5))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 18:28
S25	72	S24 and ((clean\$3 or etch\$3 or remov\$3) with (impurit\$3 or contamin\$5))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 18:29

S26	9	S25 and (oxidiz\$5 with ozone)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT;	OR	ON	2006/04/06 18:30
S27	3965	((oxidiz\$5 with surface\$1) with (impurit\$3 or contamin\$5))	IBM_TDB US-PGPUB; USPAT; USOCR;	OR	ON	2006/04/05 17:17
			EPO; JPO; DERWENT; IBM_TDB			
S28	2474	S27 and ((clean\$3 or etch\$3 or remov\$3) with (impurit\$3 or contamin\$5))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/05 17:17
S29	216	S28 and (oxidiz\$5 with ozone)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/05 17:18
S30	67	S29 and ((bond\$3 or combin\$3 or attach\$3) with (wafer\$1 or substrate\$1))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/05 17:23
S31	1174	(438/455):CCLS:	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 15:49
S32	110	S31 and (ozone or "O.sub.3")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 16:35
S33	465	(438/471);CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 16:00

S34	756	(438/974).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 16:11
S35	1681	((257/E21.088) or (257/E21.122) or (257/E21.496) or (257/E21: 512)).CCLS:	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 16:37
S36	120	S35 and (ozone or "O.sub.3")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/04/06 16:35
S37	594	(257/E21.122).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/04/06 16:38